

SLM120N03G 30V N - Channel MOSFET

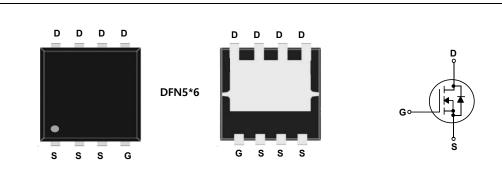
General Description

This Power MOSFET is produced using Msemitek's advanced Shielding Gate MOSFET technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as DC/DC converters and high efficiency switching for power management in portable and battery operated products.

Features

- N-Channel:30V 120A

 - $\begin{array}{l} {\sf R}_{{\sf DS}({\sf on}){\sf Typ}}{=}\;1.2\;m\Omega @{\sf V}_{{\sf GS}}{=}\;10{\sf V} \\ {\sf R}_{{\sf DS}({\sf on}){\sf Typ}}{=}\;1.6\;m\Omega @{\sf V}_{{\sf GS}}{=}\;4.5{\sf V} \end{array}$
- Very Low On-resistance R_{DS(ON)}
- Low Crss
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	SLM120N03G	Units	
V _{DSS}	Drain-Source Voltage		30	V
ID	Drain Current - Continuous ($T_c = 25^{\circ}C$)	120	А	
ID	- Continuous (T _c = 100°C)	78	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	480	А
V _{GSS}	Gate-Source Voltage		±20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	150	mJ
PD	Power Dissipation ($T_c = 25^{\circ}C$)		120	W
R _{0JC}	Thermal Resistance, Junction to Case	1.04	°C/W	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C	
ΤL	Maximum lead temperature for soldering pur 1/8" from case for 5 seconds	300	°	

* Drain current limited by maximum junction temperature.

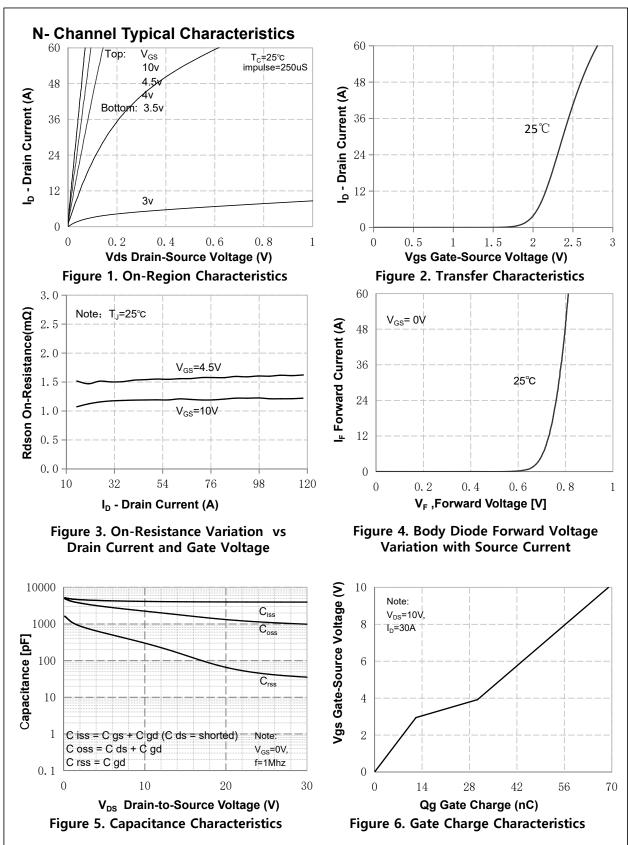
Part Number		Top Marking	Package		Packing Method	MOQ		QTY	
SLM120N03G SLM120N03G DF		DFN	N5*6 Tape & Reel		5000		50000		
Elect	rical Ch	aracteristics	T _c =	= 25°C ι	inless otherwise noted				
Symbol		Parameter			Test Conditions	Min	Тур	Max	Unit
-	aracterist	tics					,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		
				/ = 0	V L = 250 ··· A	20			V
BV _{DSS}	Drain-Source Breakdown Voltage				$V, I_D = 250 \text{ uA}$	30			-
I _{DSS}	Zero Gate	Voltage Drain Current			$V, V_{GS} = 0 V$			1	uA
1	Cata Rady	Lookago Current For			4V, T _C = 125°C 0V, V _{DS} = 0 V			50 100	uA
IGSSF	Gate-Body Leakage Current, Forward Gate-Body Leakage Current, Reverse			-	$20 \text{ V}, \text{ V}_{\text{DS}} = 0 \text{ V}$			-100	nA nA
IGSSR	Oale-Douy	Leakage Guilent, New		/GS2	.0 v, v _{DS} – 0 v			-100	
On Cha	aracterist	ics					r		
$V_{\text{GS(th)}}$	Gate Threshold Voltage			V _{DS} = V	′ _{GS} , I _D = 250 uA	1.2	1.5	2.0	V
R _{DS(on)} Static Drain-Source On-Resistance		n-Source		V _{GS} =10 V, I _D = 20A			1.2	1.8	mΩ
		`	V _{GS} =4.	5 V, I _D = 20A		1.6	2.2	11112	
Dynam	ic Charao	cteristics							
Ciss	Input Capa	acitance					4050		pF
C_{oss}	Output Capacitance Reverse Transfer Capacitance			/ _{DS} = 1 = 1.0 M	5 V, V _{GS} = 0 V, /Hz		1710		pF
C _{rss}				- 1.01			140		pF
Switch	ing Chara	acteristics							
t _{d(on)}	Turn-On Delay Time						18		ns
tr	Turn-On R	lise Time	\ \	V _{GS} =10V, V _{DS} =15V,			11		ns
t _{d(off)}	Turn-Off D	Off Delay Time			Ω, I _D =50A (Note 3)		64		ns
t _f	Turn-Off F	all Time					11		ns
Qg	Total Gate	Charge	\ \	V _{DS} = 10 V, I _D =30A,			69	-	nC
Q _{gs}		Gate-Source Charge			OV (Note 3)		12		nC
Q_{gd}	Gate-Drain	n Charge					17		nC
Drain-	Source Di	iode Characteristi	ics and	l Max	imum Ratings				
Is	Maximum Continuous Drain-Source Diode Forward Current							120	А
Іѕм		Pulsed Drain-Source D						480	Α
V _{SD}				_	′, I _{SD} =20A,TJ = 25℃	1	1	1.2	V

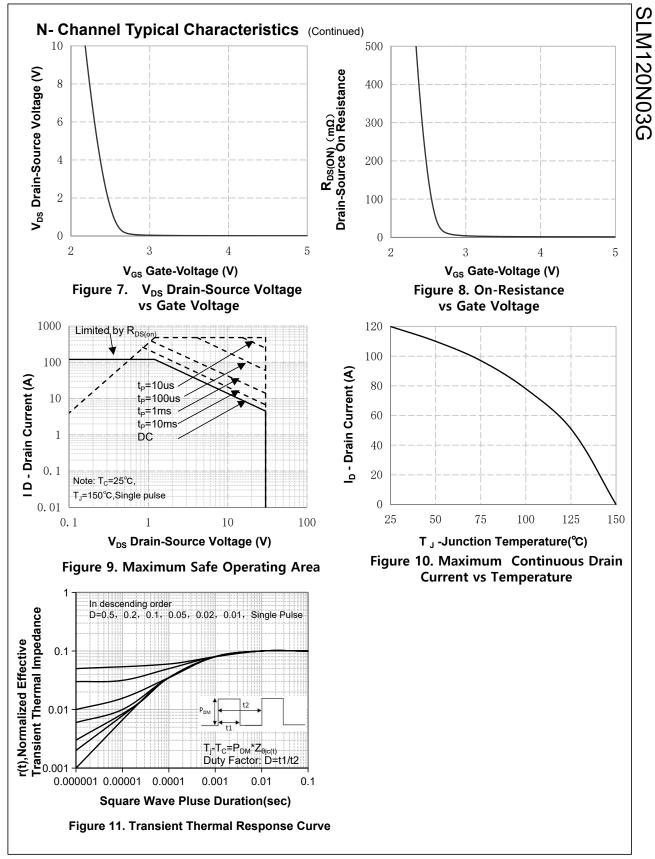
Notes:

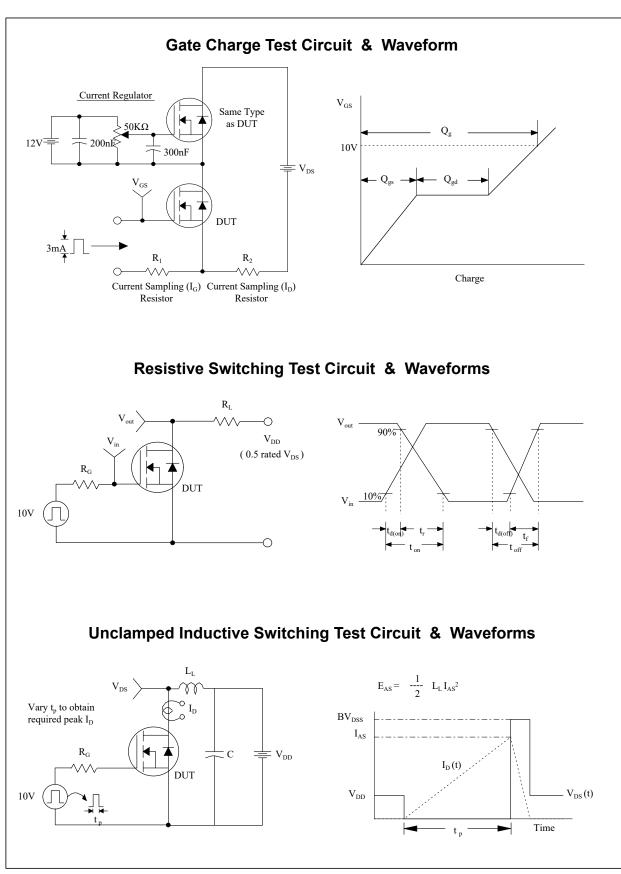
Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
EAS condition: T_J =25°C, V_{DD} =15V, V_G =10V, L=0.5mH,
Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%

SLM120N03G

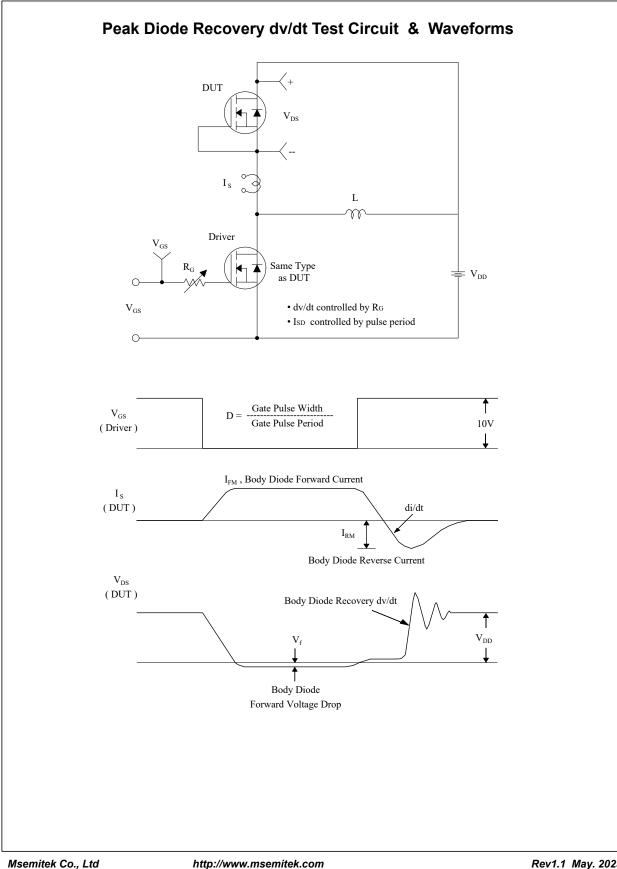
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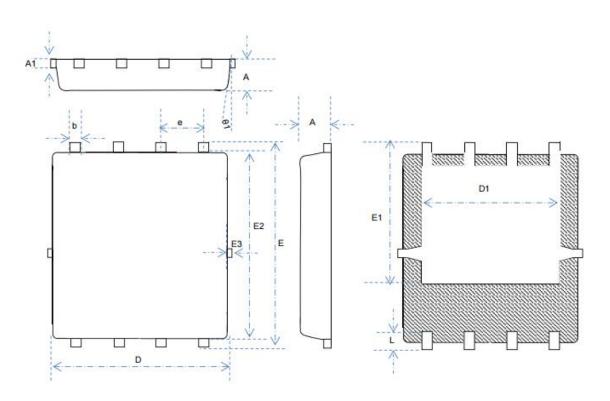


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SLM120N03G

DFN 5*6 OUTLINE



SYMBOL	Mechanical Dimensions/mm			0.0.000	Mechanical Dimensions/mm			
	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX	
A	0.85	0.95	1.05	D	5.10	5.20	5.30	
A1	0.254 REF			е	1.270 TYPE			
b	25	0.30	<u>19</u>	D1	3.90	<mark>4</mark> .0	4.10	
E	5.85	6.05	6.25	L	0.54	0.64	0.74	
E1	3. <mark>9</mark> 0	4.10	4. 30					
E2	5.45	5.55	5.65	0 1	80	100	120	
E3	-	-	0.15					

NAME	DFN 5*6 OUTLINE	UNIT	mm	DESIGNED	Shawn	THIRD ANGLE SYSTEM
DWGNO		PAGE	1 OF 1	CHECKED		
VERSION	Ver1.0	ISSUE DATE		APPROVED		

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